1200 V, 80 mΩ, 31 A

NTHL080N120SC1

Features

- Typ. $R_{DS(on)} = 80 \text{ m}\Omega$
- Ultra Low Gate Charge (typ. $Q_{G(tot)} = 56 \text{ nC}$)
- Low Effective Output Capacitance (typ. C_{oss} = 80 pF)
- 100% UIL Tested
- These Devices are RoHS Compliant

Typical Applications

- UPS
- DC/DC Converter
- Boost Inverter

MAXIMUM RATINGS (T_J = 25° C unless otherwise noted)

, , , , , , , , , , , , , , , , , , , ,						
Parameter			Symbol	Value	Unit	
Drain-to-Source Voltage	Voltage		V _{DSS}	1200	V	
Gate-to-Source Voltage			V _{GS}	-15/+25	V	
Recommended Opera- tion Values of Gate-to- Source Voltage	T _C < 175°C		V _{GSop}	-5/+20	V	
Continuous Drain Current $R_{\theta JC}$	Steady State	$T_C = 25^{\circ}C$	Ι _D	31	A	
Power Dissipation $R_{\theta JC}$			PD	178	W	
Continuous Drain Current $R_{\theta JC}$	Steady State	T _C = 100°C	۱ _D	22	A	
Power Dissipation $R_{\theta JC}$			PD	89	W	
Pulsed Drain Current (Note 2)	T _A = 25°C		I _{DM}	132	A	
Single Pulse Surge Drain Current Capability	$\begin{array}{l} T_{A} = 25^\circC, t_{p} = 10 \; \mu s, \\ R_{G} = 4.7 \; \Omega \end{array}$		I _{DSC}	132	A	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	–55 to +175	°C	
Source Current (Body Diode)			۱ _S	18	А	
Single Pulse Drain–to–Source Avalanche Energy ($I_{L(pk)}$ = 18.5 A, L = 1 mH) (Note 3)			E _{AS}	171	mJ	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Junction-to-Case (Note 1)	$R_{\theta JC}$	0.84	°C/W
Junction-to-Ambient (Note 1)	$R_{\theta JA}$	40	°C/W

1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

2. Repetitive rating, limited by max junction temperature. 3. E_{AS} of 171 mJ is based on starting $T_J = 25^{\circ}$ C; L = 1 mH, $I_{AS} = 18.5$ A,

 $V_{DD} = 120 \text{ V}, \text{ V}_{GS} = 18 \text{ V}.$



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V _{(BR)DSS}	R _{DS(on)} MAX	I _D MAX
1200 V	110 mΩ @ 20 V	31 A







MARKING DIAGRAM



ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

ELECTRICAL CHARACTERISTICS

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
OFF CHARACTERISTICS						
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0 V, I _D = 1 mA	1200	-	-	V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} /T _J	$I_D = 1$ mA, referenced to $25^{\circ}C$	_	700	_	mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	V_{GS} = 0 V, V_{DS} = 1200 V, T_{J} = 25°C	-	-	100	μA
		V_{GS} = 0 V, V_{DS} = 1200 V, T_{J} = 175°C	-	-	1	mA
Gate-to-Source Leakage Current	I _{GSS}	V_{GS} = +25/-15 V, V_{DS} = 0 V	-	-	±1	μA
ON CHARACTERISTICS	•			•		
Gate Threshold Voltage	V _{GS(th)}	$V_{GS} = V_{DS}, I_D = 5 \text{ mA}$	1.8	2.7	4.3	V
Recommended Gate Voltage	V _{GOP}		-5	-	+20	V
Drain-to-Source On Resistance	R _{DS(on)}	V_{GS} = 20 V, I _D = 20 A, T _J = 25°C	-	80	110	mΩ
		V_{GS} = 20 V, I _D = 20 A, T _J = 150°C	-	114	-	
Forward Transconductance	9 _{FS}	V _{DS} = 20 V, I _D = 20 A	-	13	-	S
CHARGES, CAPACITANCES & GATE	RESISTANCE			•		
Input Capacitance	C _{ISS}	V_{GS} = 0 V, f = 1 MHz, V_{DS} = 800 V	-	1112	-	pF
Output Capacitance	C _{OSS}		-	80	-	
Reverse Transfer Capacitance	C _{RSS}		-	6.5	-	
Total Gate Charge	Q _{G(tot)}	$V_{GS} = -5/20$ V, $V_{DS} = 600$ V, $I_{D} = 20$ A	-	56	-	nC
Gate-to-Source Charge	Q _{GS}		-	11	-	
Gate-to-Drain Charge	Q _{GD}		-	12	-	
Gate Resistance	R _G	f = 1 MHz	-	1.7	-	Ω
SWITCHING CHARACTERISTICS						
Turn-On Delay Time	t _{d(on)}	$V_{GS} = -5/20 \text{ V}, \text{ V}_{DS} = 800 \text{ V},$	-	13	-	ns
Rise Time	t _r	I _D = 20 A, R _G = 4.7 Ω, Inductive Load	-	20	-	
Turn-Off Delay Time	t _{d(off)}		-	22	-	
Fall Time	t _f		-	10	-	
Turn-On Switching Loss	E _{ON}		-	258	-	μJ
Turn-Off Switching Loss	E _{OFF}		-	52	-	
Total Switching Loss	E _{TOT}		-	311	-	
DRAIN-SOURCE DIODE CHARACTEI	RISTICS					
Continuous Drain-to-Source Diode Forward Current	I _{SD}	V_{GS} = -5 V, T_{J} = 25°C	-	-	18	A
Pulsed Drain-to-Source Diode For- ward Current (Note 2)	I _{SDM}	V_{GS} = -5 V, T_{J} = 25°C	-	-	132	A
Forward Diode Voltage	V _{SD}	V_{GS} = -5 V, I_{SD} = 10 A, T_{J} = 25°C	-	4	-	V
Reverse Recovery Time	t _{RR}	V _{GS} = -5/20 V, I _{SD} = 20 A,	-	16	-	ns
Reverse Recovery Charge	Q _{RR}	dl _S /dt = 1000 A/μs	-	62	-	nC
Reverse Recovery Energy	E _{REC}	1	-	5	-	μJ
Peak Reverse Recovery Current	I _{RRM}	1	-	8	_	А

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

TYPICAL CHARACTERISTICS $T_J = 25^{\circ}C$ unless otherwise noted



Figure 1. On Region Characteristics



Figure 2. Normalized On–Resistance vs. Drain Current and Gate Voltage











Figure 4. On-Resistance vs. Gate-to-Source Voltage



Figure 6. Source-to-Drain Diode Forward Voltage vs. Source Current



Figure 7. Gate Charge Characteristics



Figure 8. Capacitance vs. Drain-to-Source Voltage







Figure 11. Forward Bias Safe Operating Area



Figure 10. Maximum Continuous Drain **Current vs. Case Temperature**



Figure 12. Single Pulse Maximum Power Dissipation

TYPICAL CHARACTERISTICS $T_J = 25^{\circ}C$ unless otherwise noted





PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Marking	Package	Packing Method	Reel Size	Tape Width	Quantity
NTHL080N120SC1	NTHL080N120SC1	TO-247 Long Lead	Tube	N/A	N/A	30 Units



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